## Amendments to the Claims:

This listing of claims will replace all prior versions, and listings, of claims in the application:

## Listing of Claims:

Claims 1 and 2 (Canceled).

- 3. (Currently amended) The disk enclosure of claim [[2]] 5, wherein the first plurality of elements includes at least one of a first temperature sensor, a first memory, and a first backplane controller.
- 4. (Currently amended) The disk enclosure of claim 3, wherein the backplane controller is coupled to a first port bypass circuit, the <u>first</u> port bypass circuit operable to bypass a <u>first</u> disk drive.
- 5. (Currently amended) A disk enclosure comprising:
  - a first enclosure controller coupled to first and second buses;
  - a first plurality of elements coupled to the first bus;
  - a first voltage circuit powering the first enclosure controller and the first plurality of elements in a first power domain;
  - a second enclosure controller coupled to third and fourth buses;
  - a second plurality of elements coupled to the fourth bus;
  - a second voltage circuit powering the second enclosure controller and the second plurality of elements in a second power domain;
  - a first switch coupled between the first and the third buses, the first switch operable to de-couple the first and the third buses when the voltage output from the second voltage circuit falls below a predetermined threshold; and

The disk enclosure of claim 3, wherein:

the first controller is coupled to a third bus;

the second controller is coupled to a fourth bus;

a second switch coupled between the third and the fourth the second and the fourth buses, the second switch operable to de-couple the third and the fourth the second and the fourth buses when the voltage output from the first voltage circuit falls below [[a]] the predetermined threshold.

Claim 6 (Canceled).

- 7. (Currently amended) The disk enclosure of claim [[6]] 4, wherein the second plurality of elements includes at least one of a second temperature sensor, a second memory, and a second backplane controller.
- 8. (Currently amended) The disk enclosure of claim 7, wherein the second backplane controller is coupled to a <u>second</u> port bypass circuit, the <u>second</u> port bypass circuit operable to bypass a <u>second</u> disk drive.
- 9. (Currently amended) The disk enclosure of claim [[7]] 5, wherein:

the first enclosure controller is coupled to a fifth bus;

the second enclosure controller is further coupled to a sixth bus;

a third switch coupled between the fifth bus and a seventh bus, the third switch operable to de-couple the fifth and the seventh buses when the voltage output from the first voltage circuit falls below [[a]] the predetermined threshold; and

a fourth switch coupled between the sixth bus and the seventh bus, the fourth switch operable to de-couple the sixth and seventh buses when the voltage output from the second voltage circuit falls below [[a]] the predetermined threshold.

- 10. (Original) The disk enclosure of claim 9, wherein the seventh bus is further coupled to a third plurality of elements.
- 11. (Previously presented) The disk enclosure of claim 10, wherein the third plurality of elements includes at least one of a third temperature sensor, a third memory, a third backplane controller, and an I/O expander.

- 12. (Original) The disk enclosure of claim 11, wherein the I/O expander is coupled to at least one battery.
- 13. (Original) The disk enclosure of claim 11, wherein the I/O expander is coupled to at least one power supply.
- 14. (Currently amended) A disk enclosure comprising:
  - a first <u>enclosure</u> controller powered by a first voltage circuit and coupled to a first bus; a second <u>enclosure</u> controller powered by a second voltage circuit and coupled to a second bus;
  - a first switch coupled between the first bus and a third bus, the first switch operable to de-couple the first and the third buses when the voltage output from the first voltage circuit falls below a predetermined threshold; and
  - a second switch coupled between the second bus and the third bus, the second switch operable to de-couple the second and the third buses when the voltage output from the first voltage circuit falls below [[a]] the predetermined threshold.
- 15. (Previously presented) The disk enclosure of claim 14, wherein the third bus is coupled to a first plurality of elements.
- 16. (Original) The disk enclosure of claim 15, wherein the first plurality of elements includes at least one of a temperature sensor, a memory, a backplane controller, and an I/O expander.
- 17. (Original) The disk enclosure of claim 16, wherein the I/O expander is coupled to at least one battery.
- 18. (Original) The disk enclosure of claim 16, wherein the I/O expander is coupled to at least one power supply.
- 19. (Currently amended) The disk enclosure of claim 15, wherein:

the first enclosure controller is coupled to a fourth bus;

the second enclosure controller is coupled to a fifth bus; and

a third switch coupled between the fourth and the fifth buses, the third switch operable to de-couple the fourth and the fifth buses when the voltage output from the second voltage circuit falls below a predetermined threshold.

- 20. (Original) The disk enclosure of claim 19, wherein the fourth bus is coupled to a second plurality of elements.
- 21. (Original) The disk enclosure of claim 20, wherein the second plurality of elements includes at least one of a temperature sensor, a memory, and a backplane controller.
- 22. (Original) The disk enclosure of claim 21, wherein the backplane controller is coupled to a port bypass circuit, the port bypass circuit operable to bypass a disk drive.
- 23. (Currently amended) The disk enclosure of claim 20, wherein:

the first enclosure controller is coupled to a sixth bus;

the second enclosure controller is coupled to a seventh bus; and

- a fourth switch coupled between the sixth and the seventh buses, the fourth switch operable to de-couple the sixth and seventh buses when the voltage output from the first voltage circuit falls below a predetermined threshold.
- 24. (Original) The disk enclosure of claim 23, wherein the seventh bus is coupled to a third plurality of elements.
- 25. (Original) The disk enclosure of claim 24, wherein the third plurality of elements includes at least one of a temperature sensor, a memory, and a backplane controller.
- 26. (Original) The disk enclosure of claim 25, wherein the backplane controller is coupled to a port bypass circuit, the port bypass circuit operable to bypass a disk drive.
- 27. (Previously presented) The disk enclosure of claim 1, wherein the first and the second buses comprise I2C buses.
- 28. (Previously presented) The disk enclosure of claim 14, wherein the first, the second, and the third buses comprise I2C buses.